



MJ P-Channel Enhancement Mode Power MOSFET

Description

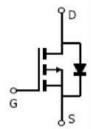
The MJ60P45K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

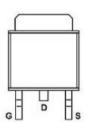
- $V_{DS} = -60V, I_{D} = -45A$ R_{DS(ON)} <35mΩ @ V_{GS}=-10V
- ♦ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high EAS
- ◆ Excellent package for good heat dissipation

Application

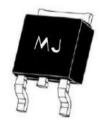
- ♦ Power switching application
- ◆ Hard switched and high frequency circuits
- ◆ Uninterruptible power supply







Marking and pin assignment



TO-252-2L top view

100% UIS TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ60P45K	MJ60P45K	TO-252-2L	ii ii	-	2

Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	-60	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	ΙD	-45	А
Drain Current-Continuous(Tc =100℃)	I D(100℃)	-31.8	А
Pulsed Drain Current	Ідм	180	А
Maximum Power Dissipation	Po	110	W
Derating factor		0.73	W/°C
Single pulse avalanche energy (Note 5)	Eas	168	mJ
Operating Junction and Storage Temperature Range	Тл,Тѕтс	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	1.36	°C/W
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Electrical Characteristics (Tc =25°Cunless otherwise noted)

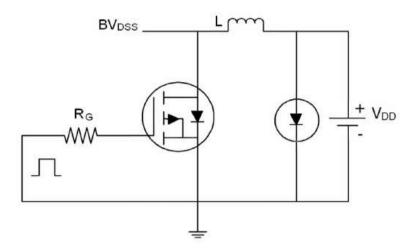
Parameter	Symbol	Condition	Min	Тур	Max	Uni
Off Characteristics	'					
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =-250µA	-60	-	-	V
Zero Gate Voltage Drain Current	loss	V _{DS} =-60V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	'					
Gate Threshold Voltage	VGS(th)	Vos=Vos ,Io=-250µA	-2.0	-2.6	-3.5	V
Drain-Source On-State Resistance	Rds(on)	V _{GS} =-10V, I _D =-20A	-	31	35	mΩ
Forward Transconductance	grs	V _{DS} =-5V,I _D =-20A	-	20	-	S
Dynamic Characteristics (Note 4)	'	1	1			
Input Capacitance	Clss		-	2049	-	PF
Output Capacitance	Coss	V _{DS} =-30V,V _{GS} =0V F=1.0MHz	-	112.7	-	PF
Reverse Transfer Capacitance	Crss		-	88.7	-	PF
Switching Characteristics (Note 4)				ı		
Turn-on Delay Time	t _{d(on)}		-	13	-	nS
Turn-on Rise Time	tr	V _{DD} =-30V,I _D =-20A	-	14	-	nS
Turn-Off Delay Time	t _{d(off)}	Vgs=-10V,Rgen=3Ω	-	39	-	nS
Turn-Off Fall Time	tr		-	15	-	nS
Total Gate Charge	Qg		-	35.1	-	nC
Gate-Source Charge	Qgs	V _{DS} =-30V,I _D =-20A V _{GS} =-10V	-	9	-	nC
Gate-Drain Charge	Q _{gd}		-	7.9	-	nC
Drain-Source Diode Characteristics		I	1	I	I	I.
Diode Forward Voltage (Note 3)	VsD	V _{GS} =0V,I _S =-20A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	-45	А
Reverse Recovery Time	trr	TJ=25°C, IF=-20A	-	-	40	nS
Reverse Recovery Charge	Qrr	di/dt= 100A/µs (Note 3)	_	_	70	nC

Notes:

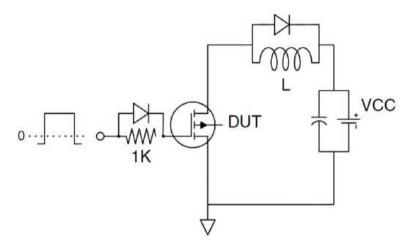
- 1 Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- ④ Guaranteed by design, not subject to production



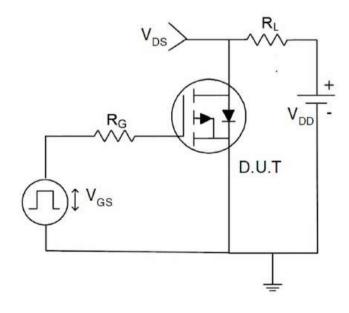
Test circuit



Eas test Circuit



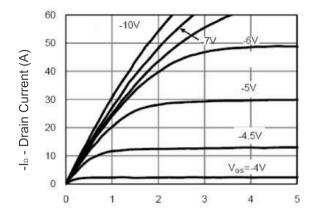
Gate charge test Circuit

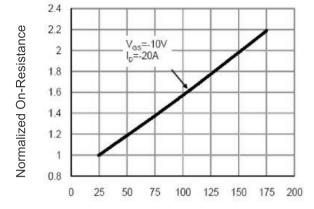


Switch Time Test Circuit



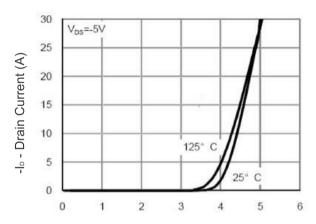
Typical Electrical and Thermal Characteristics (Curves)



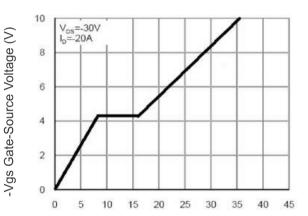


-Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



T_J -Junction Temperature(°C) Figure 4 Rdson-Junction Temperature

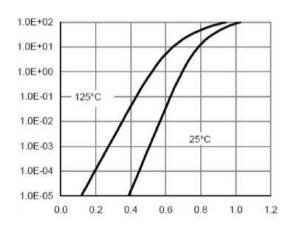


-Vgs Gate-Source Voltage (V) Figure 2 Transfer Characteristics

50 45 40 35 30 V_{GS}=-10V 25 20 0 5 10 15 20 25 30

Rdson On-Resistance(mΩ)

Qg Gate Charge (nC) Figure 5 Gate Charge



-I_D - Drain Current (A)

Figure 3 Rdson- Drain Current

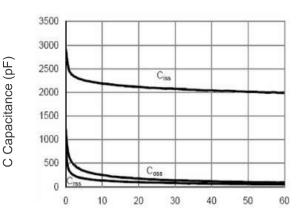
-Vsd Source-Drain Voltage (V) Figure 6 Source- Drain Diode Forward

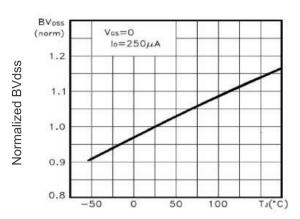
Is - Reverse Drain Current (A)



-l_o - Drain Current (A)

0.01

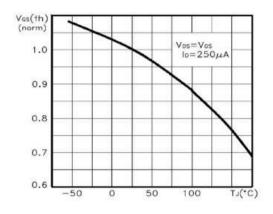




-Vds Drain-Source Voltage (V) Figure 7 Capacitance vs Vds

1000.0 100.0 10µs 10.0 1ms 1.0 DC Г_{J(Мах)}=175° С 0.1 T_C=25° C 0.0 10

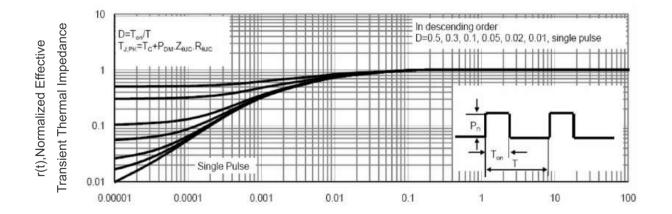
T_J -Junction Temperature(°C) Figure 9 BVpss vs Junction Temperature



-Vds Drain-Source Voltage (V) Figure 8 Safe Operation Area

100

T_J -Junction Temperature(°C) Figure 10 V_{GS(th)} vs Junction Temperature



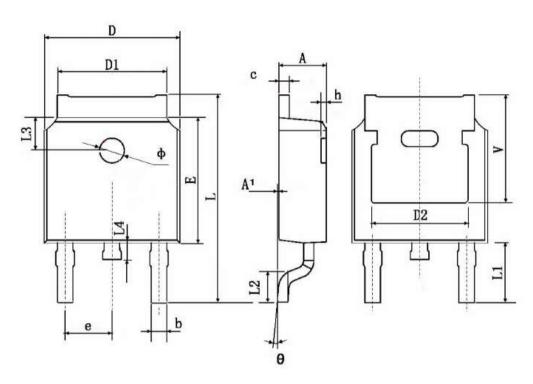
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-252 Package Information



Cumbal	Dimensions	In Millimeters	Dimension	s In Inches
Symbol	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.8	30 TYP.	0.190 TYP.	
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600	TYP.	0.063	TYP.
L4	0.600	1.000	0.024	0.039
Ф	1.100	1.300	0.043	0.051
θ	0°	8°	0.	8°
h	0.000	0.300	0.000	0.012
V	5.350	TYP.	0.211	TYP.





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